

Product / Process Change Notification



N° 2018-067-A

Dear Customer,

Please find attached our INFINEON Technologies PCN:

Introduction of an additional wafer production and wafer test location Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia for products in B4CD technology in package PG-DSO-8 and PG-SSOP-14

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **10. June 2020**.
- Infineon aligns with the widely-recognized JEDEC STANDARD “**JESD46**“, which stipulates:
“**Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.**”

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG
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Chairman of the Supervisory Board: Dr. Wolfgang Eder
Management Board: Dr. Reinhard Ploss (CEO), Dr. Helmut Gassel, Jochen Hanebeck, Dr. Sven Schneider
Registered Office: Neubiberg
Commercial Register: München HRB 126492

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► **Products affected:** Please refer to attached affected product list 1_cip18067_A

► **Detailed Change Information:**

Subject: Introduction of an additional wafer production and wafer test location Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia for products in B4CD technology in package PG-DSO-8 and PG-SSOP-14

Reason: Expansion of wafer production and wafer test location to assure continuity of supply and enable flexible manufacturing.

Description:	<u>Old</u>	<u>New</u>
	wafer production and test location	■ Infineon Technologies Austria AG, Villach, Austria

► **Product Identification:** Wafer lot numbers from Villach start with VExxxxxx.
Wafer lot numbers from Kulim with 1Exxxxxx
Traceability assured via date code.
No change in SP ordering number

► **Impact of Change:** Based on the qualification performed, Infineon does not expect any negative impact on quality, function and reliability. No change in fit, form and function expected.
DeQuMa-IDs: SEM-PW-13 / SEM-TF-01

► **Attachments:** Affected product list 1_cip18067_A

► **Time Schedule:**

- | | |
|-------------------------------|---|
| ■ Final qualification report: | available |
| ■ First samples available: | on request |
| ■ Intended start of delivery: | 02-November-2020 or earlier after customer approval |

If you have any questions, please do not hesitate to contact your local Sales office.

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Sales name	SP number	OPN	Package
TLE4678-2EL	SP000903204	TLE46782ELXUMA1	PG-SSOP-14
TLF4949EJ	SP000766896	TLF4949EJXUMA1	PG-DSO-8
TLF80511EJ V33	SP001207626	TLF80511EJV33XUMA1	PG-DSO-8
TLF80511EJ V50	SP001136780	TLF80511EJV50XUMA1	PG-DSO-8
TLS710B0EJ V50	SP001208582	TLS710B0EJV50XUMA1	PG-DSO-8
TLS715B0EJ V50	SP001335052	TLS715B0EJV50XUMA1	PG-DSO-8